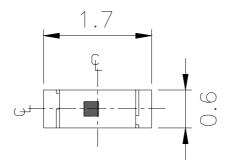
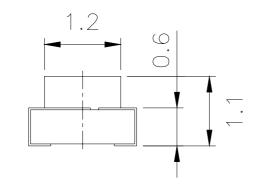


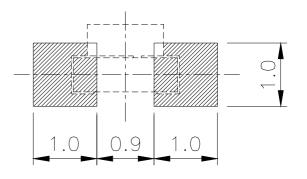
Package Outline Dimensions

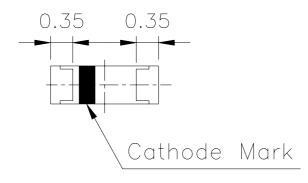












Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	I_{F}	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	100	mA	
Power Dissipation	Pd	110	mW	
Electrostatic Discharge(HBM)	ESD	150	V	
Operating Temperature	Topr	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\! \mathbb{C}$	
Soldering Temperature	Tsol	Reflow Soldering : 260°C for 10sec. Hand Soldering : 350°C for 3 sec		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition	
Luminous Intensity	I_V	11.5		28.5	mcd		
Viewing Angle	2 \theta 1/2		130		deg		
Peak Wavelength	λр		468		nm		
Dominant Wavelength	λd	465.0		475.0	nm	$I_F = 5mA$	
Spectrum Radiation Bandwidth	Δλ		35		nm		
Forward Voltage	V_{F}	2.60		3.00	V		
Reverse Current	I_R			50	μ A	$V_R = 5V$	

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.05V

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Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
Z	X	465.0	470.0		
	Y	470.0	475.0	nm	$I_F=5mA$

Bin Range Of Luminous Intensity

		<u> </u>		
Bin	Min	Max	Unit	Condition
L1	11.5	14.5		
L2	14.5	18.0	1	I _F =5mA
M1	18.0	22.5	mcd	
M2	22.5	28.5		

Bin Range Of Forward Voltage

Group	Bin	Min	Max	Unit	Condition	
T	28	2.60	2.70	-		
	29	2.70	2.80		T 6 A	
	30	2.80	2.90	V	I _F =5mA	
	31	2.90	3.00			

Notes:

- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.05V

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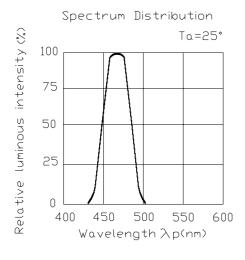
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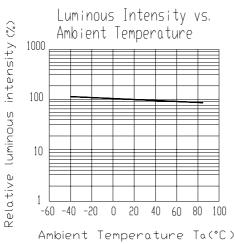
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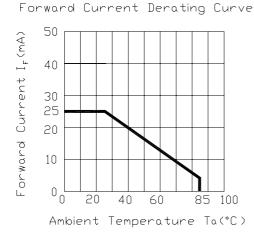
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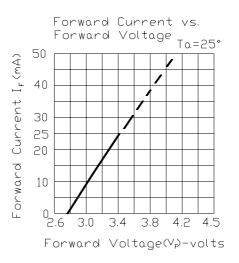


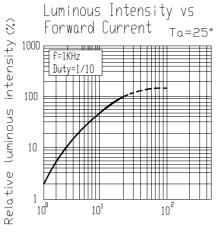
Typical Electro-Optical Characteristics Curves

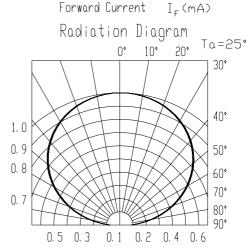












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Label explanation

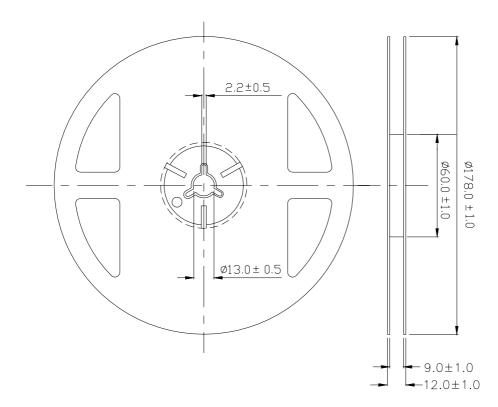
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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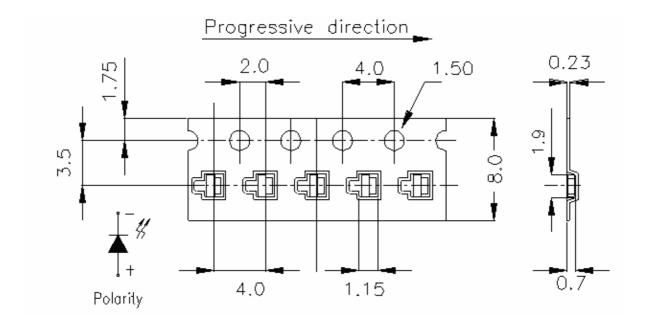
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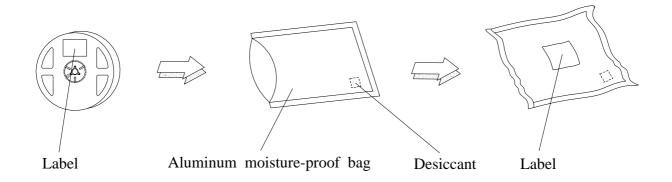


Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min.5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85% RH	1000 Hrs.	22 PCS.	0/1

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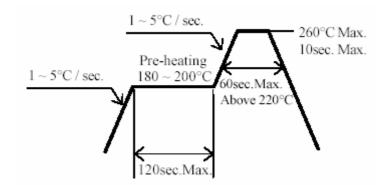
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Precautions For Use

- 1. Over-current-proof
 - Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).
- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
 - 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
 - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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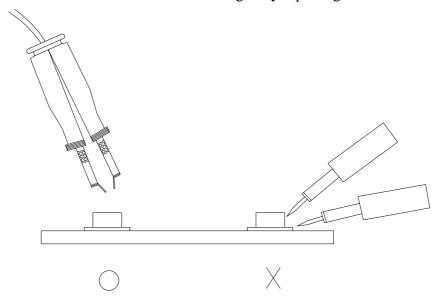


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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